

General Description

The MAX9895A is a complete audio subsystem for active noise-cancelling (ANC) stereo headsets. The device features three stages for each right and left channel. A microphone preamplifier, an analog sound processing block, and a headphone amplifier combine to create a simple and very flexible active noise-canceling system.

The MAX9895A features a feed-forward architecture. where outside microphones sense the ambient noise and on-board analog sound processing generates the compensation signal needed for noise reduction. This further supports the mechanical isolation of the headset by attenuating sound that leaks through the mechanics of the headphone.

The microphone preamplifiers feature programmable gain, allowing alignment of the microphone and driver tolerances and left-right channel matching. The headphone amplifiers are output capacitorless and can deliver 33mW into a 16Ω transducer.

The MAX9895A has three modes of operation: ANC on, PTL, and ANC off. The ANC-on mode demonstrates the noise-canceling performance of the device. PTL (pushto-listen) mode sends the microphone signals directly to the headphones to temporarily listen to the surroundings. ANC off disables noise-canceling, but allows use of the headphone amplifiers during music playback.

The MAX9895A is available in a space-saving WLP or TQFN package and is specified over the -40°C to +85°C extended temperature range.

Applications

Noise-Cancelling Headphones/Headsets Headsets for Mobile Communication Mobile Phones Portable Gaming Devices E-Books

Features

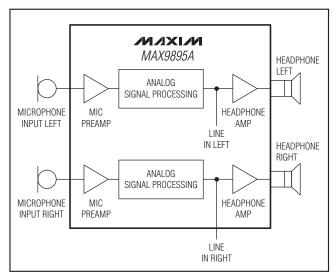
- ♦ 2.7V to 4.5V Operation
- **♦ Low Headphone Amplifier Noise**
- **♦ Low-Noise Microphone Preamplifiers with 2.2V Bias**
- ♦ Stereo 33mW into 16Ω Capacitorless Headphone **Amplifiers**
- ♦ Microphone Output Path Available for Speech **Transmission**
- ♦ Adjustable Microphone Gain by I²C Interface or **External Resistors**
- **♦ Low External Component Count**

Ordering Information

PART	TEMP RANGE	PIN- PACKAGE	GAIN (V/V)
MAX9895AEWX+	-40°C to +85°C	36 WLP	1
MAX9895AETL+	-40°C to +85°C	40 TQFN-EP*	1

⁺Denotes a lead(Pb)-free/RoHS-compliant package.

Simplified Block Diagram



Pin Configurations appear at end of data sheet.

^{*}EP = Exposed pad.

ABSOLUTE MAXIMUM RATINGS

V _{DD} to GND	0.3V to +6V
PVDD to PGND	0.3V to +6V
PVDD to V _{DD}	0.1V to +0.1V
CPVDD to PVDD	Internally shorted
PGND to GND	0.1V to +0.1V
SDA, SCL	0.3V to +6V
LINEIN	0.3V to +6V
Any Other Pin	
Duration of Short Circuit Between HPOUT_	, ,
and GND	Continuous
Duration of Short Circuit Between MICBIAS	}
and VDD, GND	Continuous
Duration of Short Circuit Between V _{MID}	
and V _{DD} , GND	Continuous

Continuous Current into HPOUT	200mA
Continuous Input Current (all other pins)	±20mA
Continuous Power Dissipation ($T_A = +70$ °C)	
36-Bump, 0.4mm-Pitch WLP Single-Layer Board	
(derate 17mW/°C above +70°C)	1360mW
Maximum Current per Bump (10k hrs at +120°C)	1.7A
TQFN Package (derate 22mW/°C above +70°C)	1777mW
ESD Protection, Human Body Model	±2kV
Operating Temperature Range40°	°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range65°C	C to +150°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = V_{PVDD} = V_{CPVDD} = 3.3V, R_L = \infty, C_{VDD} = 10\mu F$ connected between V_{DD} and PGND, $C_{BIAS} = 1\mu F$ connected between V_{BIAS} and GND, $C_{FLY} = 1\mu F$ connected between C1P and C1N. $C_{HOLD} = 1\mu F$ connected between V_{MID} and PGND, $R_{PREIN} = 10k\Omega$, $R_{PREFB} = 50k\Omega$, $R_{MICBIAS} = 3.3k\Omega$, MIC signal gain in ANC mode ANC_GAIN = -11.5dB, MIC signal gain in PTL mode PTL_GAIN = -5.5dB, $V_{GAIN} = +1V/V$, $T_{A} = T_{MIN}$ to T_{MAX} , unless otherwise noted. Typical values are at $T_{A} = +25^{\circ}C$.) (Note1)

PARAMETER	SYMBOL	CONDITIONS		TYP	MAX	UNITS	
GENERAL							
	V _{DD}						
Supply Voltage Range	PVDD	Inferred by PSRR test	2.7	3.3	4.5	V	
	CPVDD						
		ANC = on		3.4	4.6		
Quiescent Supply Current	I _{DD}	ANC = off, PTL = off		2.5	3.4	mA	
		PTL = on		3.4	4.6		
Shutdown Supply Current	ISHDN	I^2C mode, $T_A = +25^{\circ}C$			12	μΑ	
Internal Reference	V _{BIAS}	Voltage on V _{BIAS}	1.25	1.3	1.35	V	
Charles Time a		Input from LINEIN_		37			
Startup Time	ton	Input from MICIN_		390		ms	
Undervoltage Lockout	UVLO	Falling threshold	2.27		2.65	V	
HEADPHONE OUTPUTS							
Line Input Resistance	RIN	MAX9895A	7	10	14	kΩ	
Output Offset Voltage	Vos	$T_A = +25^{\circ}C$		0.3	±3	mV	
Total Harmonic Distortion plus	THD+N	$R_L = 32\Omega$, $P_{OUT} = 10$ mW, $f = 1$ kHz from LINEIN_		0.002		%	
Noise	I HD+N	$R_L = 16\Omega$, $P_{OUT} = 10$ mW, f = 1kHz from LINEIN_		0.002			
Barrar Organia Bairatian But		$V_{DD} = 2.5V \text{ to } 4.5V, T_A = +25^{\circ}C$	60	70			
Power-Supply Rejection Ratio (Note 2)	PSRR	$f \le 1 \text{kHz}$, $V_{\text{IN}} = 200 \text{mV}_{\text{P-P}}$		65		dB	
(14010 2)		$f = 10kHz$, $V_{IN} = 200mV_{P-P}$		55			

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = V_{PVDD} = V_{CPVDD} = 3.3V, R_L = \infty, C_{VDD} = 10\mu F$ connected between V_{DD} and PGND, $C_{BIAS} = 1\mu F$ connected between V_{BIAS} and GND, $C_{FLY} = 1\mu F$ connected between C1P and C1N. $C_{HOLD} = 1\mu F$ connected between V_{MID} and PGND, $C_{RPREIN} = 10k\Omega$, $C_{RPREFB} = 50k\Omega$, $C_{RMICBIAS} = 3.3k\Omega$, MIC signal gain in ANC mode ANC_GAIN = -11.5dB, MIC signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode PTL_GAIN = -5.5dB, $C_{RMICBIAS} = 10k\Omega$, which is a signal gain in PTL mode

PARAMETER	SYMBOL		CONDITIONS	MIN	TYP	MAX	UNITS
Output Power	Роит	$R_L = 16\Omega$, (Note 3)	THD+N = 1%, T _A = +25°C	20	38		mW
		$R_L = 32\Omega$,	THD+N = 1%, T _A = +25°C		26		
		ANC = off, BW = 20Hz	-		9		
Output Noise Voltage	V _{ON}	ANC = off, A-weighted			6		μV _{RMS}
		ANC = on,	A-weighted		6.5		
Slew Rate	SR				0.2		V/µs
Maximum Capacitive Load	CMAXLOAD		ed oscillations ce between HPOUT_ and V _{MID})		100		рF
Click-and-Pop Level	KCP	Turn on	R _L = 32Ω, peak voltage, A-weighted, 32 samples/sec,		-73		dBV
·		Turn off	$T_A = +25^{\circ}C \text{ (Note 4)}$		-72		
_		f = 1kHz, F		57			
Crosstalk		WLP			70		dB
MICROPHONE INPUTS	•	•					•
Preamplifier Feedback Resistance	RPREFB	External		10		100	kΩ
Preamplifier Input Resistance	RPREIN	External		1		10	kΩ
Input Bias Current	I _{BIAS}	Measured	at MICIN, T _A = +25°C		1	10	nA
Microphone Input Noise Voltage	eN	BW = 20Hz measured	z to 20kHz at MICOUT_		6		μV
Minimum ANC Gain	ANCG_MIN			-18.0	-17.5	-17.0	dB
Maximum ANC Gain	ANCG_MAX	MICOLIT	a LIDOLIT	-6.0	-5.5	-5.0	dB
Minimum PTL Gain	PTLG_MIN	MICOUI_1	o HPOUT_, measured at DC	-12.0	-11.5	-11.0	dB
Maximum PTL Gain	PTLG_MAX			0	0.5	1	dB
ANC/PTL Gain Stepsize	AG_STEP	MICOUT_t	o HPOUT_, measured at DC		0.5		dB
OPA Offset		Measured to V _{BIAS}	-30		+30	mV	
Maximum Capacitive Load	CMAXLOAD	Allowed ca and all sign SPC3		15		pF	
Dynamic Range	MICDYN	0	I internal and external nodes of er, signal processing, and filter of to V _{BIAS}		±1		V

ELECTRICAL CHARACTERISTICS (continued)

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PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Maximum Output Current	lout	Current capability of preamplifier, signal processing, and filter output		±500		μΑ
PTL Attenuation		Attenuation from LINEIN_ to HPOUT_ in PTL mode		40		dB
MICROPHONE BIAS (MICBIAS F	Pin)					
MIC Bias Voltage	VMICBIAS	V _{DD} = 3.3V; 100μA < I _{MICBIAS} < 1mA	2.1	2.2	2.3	V
MIC Bias Current Limit	IMICLM			35		mA
Maximum Capacitive Load	CMAXLOAD			100		рF
MICBIAS PSRR	MB_PSRR	V _{DD} from 2.7V to 4.5V f = 20kHz	55	62 60		dB
MICBIAS Noise	MB_N			6		μV
CHARGE PUMP		1				· · · · · · · · · · · · · · · · · · ·
Charge-Pump Frequency	fosc		225	250	275	kHz
V _{MID} Output Resistance	R _{VMID}			4		Ω
DIGITAL INPUT SDA (SCL Tied	to GND: I ² C In	terface Disabled)	•			•
Input Leakage	IL	$V_{SDA} = 0V \text{ to } 3.3V$ $T_A = +25^{\circ}C$			±16	μΑ
Input Voltage High	VIH		1.8			V
Input Voltage Low	V _{IL}				0.8	V
SCL/SDA (I ² C Interface Enabled)		•			•
Input Voltage High	VIH	1.8V CMOS compatibility	1.4			V
Input Voltage Low	VIL	1.8V CMOS compatibility			0.4	V
Input Hysteresis	VIHIST			0.2		V
Input High Leakage Current	lін	$V_{IN} = 3V; T_A = +25^{\circ}C$			±1	μΑ
Input Low Leakage Current	IIL	$V_{IN} = 0$; $T_A = +25^{\circ}C$			±1	μΑ
Input Capacitance	CIN			10		рF
Output Voltage Low	VoL	$I_{OL} = 3mA; T_A = +25$ °C			0.4	V
I ² C INTERFACE						
Serial-Clock Frequency	fscl				400	kHz
Bus Free Time Between STOP and START Conditions	tBUF		1.3			μs
Hold Time (REPEATED) START Condition	tHD:STA		0.6			μs
Setup Time for a REPEATED START Condition	tsu:sta		0.6			μs

ELECTRICAL CHARACTERISTICS (continued)

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PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
SCL Pulse-Width Low	tLOW		1.3			μs
SCL Pulse-Width High	tHIGH		0.6			μs
Data Setup Time	tsu:dat		100			ns
Data Hold Time	thd:dat		0		900	ns
SDA and SCL Receiving Rise Time	t _R	(Note 5)	20 + 0.1C _B		300	ns
SDA and SCL Receiving Fall Time	tF	(Note 5)	20 + 0.1C _B		300	ns
SDA Transmitting Fall Time	tF	(Note 5)	20 + 0.1C _B		250	ns
Setup Time for STOP Condition	tsu,sto		0.6			μs
Bus Capacitance	СВ				400	рF
Pulse Width of Suppressed Spike	tsp		0		50	ns

Note 1: All devices are 100% production tested at $T_A = +25$ °C. Specifications over temperature limits are guaranteed by design.

Note 2: PSRR at any frequency is limited by resistor matching (common-mode sense architecture used to reject the modulation on VMID).

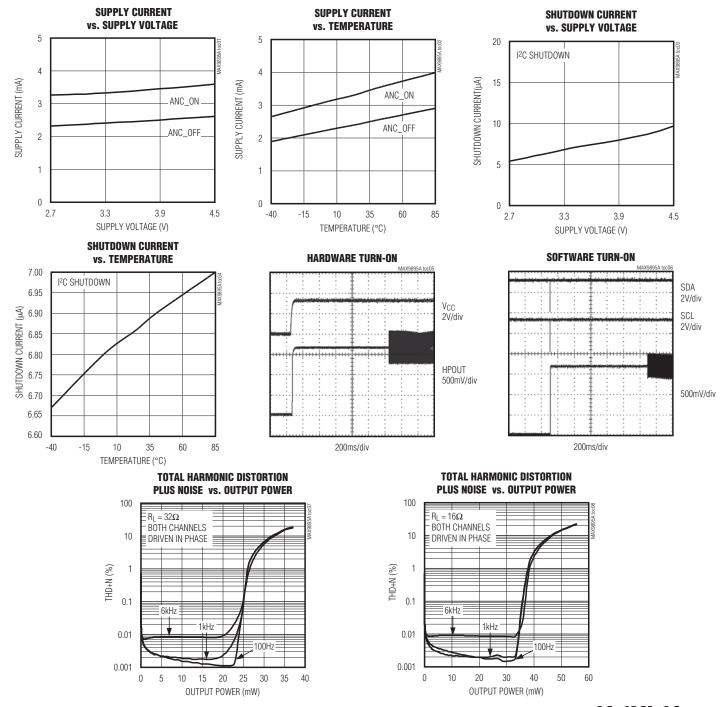
Note 3: Output power is guaranteed by measuring the RDSON of all power MOSFETs (headphone driver and charge pump).

Note 4: Line inputs AC-coupled to GND.

Note 5: CB is in pF.

Typical Operating Characteristics

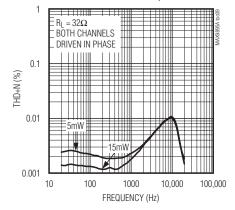
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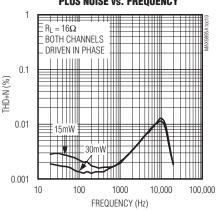
Typical Operating Characteristics (continued)

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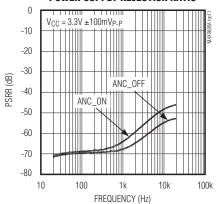
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



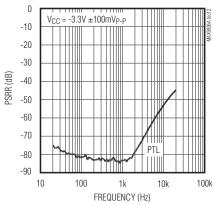
TOTAL HARMONIC DISTORTION PLUS NOISE vs. FREQUENCY



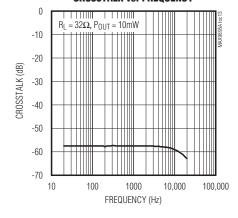
POWER-SUPPLY REJECTION RATIO



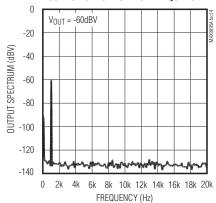
POWER-SUPPLY REJECTION RATIO



CROSSTALK vs. FREQUENCY

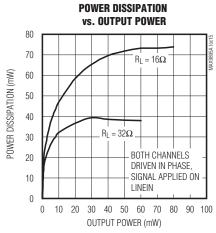


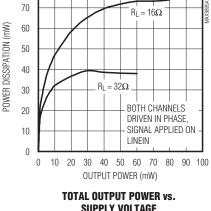
OUTPUT SPECTRUM vs. FREQUENCY

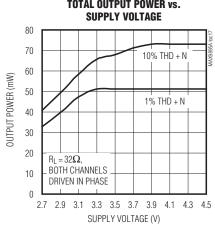


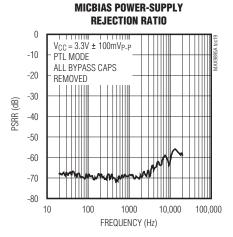
Typical Operating Characteristics (continued)

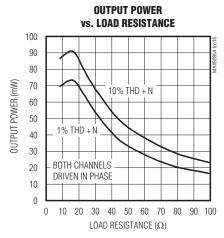
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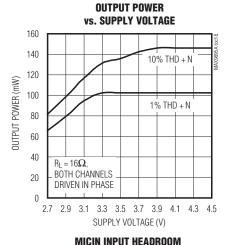


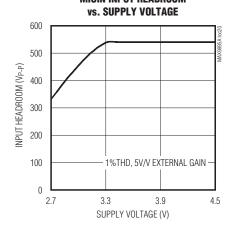












____Pin Description

PIN			EUNOTION					
TQFN	WLP	NAME	FUNCTION					
1	A6	SPR1_L	Left-Channel Signal Processing					
2	C5	MICOUT_L	Left-Channel Microphone Preamplifier Output. Apply feedback resistor to set input gain. See the <i>Microphone Output</i> section for more details.					
3	B6	MICIN_L	Left-Channel Microphone Input					
4	C6	MICBIAS	Microphone Supply Voltage. Use separate left/right MICBIAS resistors.					
5	C4	LINEIN_L	Left-Channel Audio Line Input					
6	D4	LINEIN_R	Right-Channel Audio Line Input					
7, 8	D6	GND	Signal Ground (Reference for V _{BIAS} , MICBIAS, and LINEIN)					
9	E6	MICIN_R	Right-Channel Microphone Input					
10	D5	MICOUT_R	Right-Channel Microphone Preamplifier Output. Apply feedback resistor to set input gain.					
11	F6	SPR1_R	Right-Channel Signal Processing					
12	E5	SPC1_R	Right-Channel Signal Processing					
13	F5	SPC2_R	Right-Channel Signal Processing					
14	E4	SPC3_R	Right-Channel Signal Processing					
15	F4	SPC4_R	Right-Channel Signal Processing					
16	E3	SPR2_R	Right-Channel Signal Processing					
17	F3	VBIAS	Internal Reference. Bypass V _{BIAS} to GND with a 1µF capacitor. Used for MICIN and LINEIN.					
18	E2	SPFC2_R	Right-Channel Signal Processing					
19	F2	SPFC1_R	Right-Channel Signal Processing					
20	D2	SPFO_R	Right-Channel Signal Processing					
21	F1	HPOUT_R	Right-Channel Headphone Output					
22		V _{DD}						
23	E1	PVDD	Positive Supply Voltage					
24		CPVDD						
25	D1	C1P	Charge-Pump Flying Capacitor Positive					
26	C1	C1N	Charge-Pump Flying Capacitor Negative					
27	B1	V _{MID}	Charge-Pump Output Voltage. Connect to common return of headphone. Bypass V _{MID} with a 1µF capacitor to PGND.					
28		N.C.	No Connection					
29	A1	PGND	Power Ground					
30	D3	SDA/NC-MODE	I ² C Interface Data Line. Also used as MODE select in hardware mode (SCL = GND See Table 1.					
31	C3	SCL	I ² C Interface Clock Line. Connect to GND for hardware mode.					
32	A2	HPOUT L	Left-Channel Headphone Output					

Pin Description

F	PIN	NAME	FUNCTION				
TQFN	WLP	INAIVIE	FUNCTION				
33	C2	SPFO_L	Left-Channel Signal Processing				
34	B2	SPFC1_L	Left-Channel Signal Processing				
35	А3	SPFC2_L	Left-Channel Signal Processing				
36	В3	SPR2_L	Left-Channel Signal Processing				
37	A4	SPC4_L	Left-Channel Signal Processing				
38	B4	SPC3_L	Left-Channel Signal Processing				
39	A5	SPC2_L	Left-Channel Signal Processing				
40	B5	SPC1_L	Left-Channel Signal Processing				
_	_	EP	Exposed Pad. Must be connected to PGND.				

Detailed Description

The MAX9895A is a complete audio subsystem for active noise-cancelling stereo headsets. The device features a microphone preamplifier, an analog sound processing block, and a headphone amplifier combining to create a simple and very flexible active noisecanceling system. The MAX9895A uses feed-forward architecture, creating a headphone signal that has the same amplitude, but opposite phase as outside noise that leaks through the mechanical isolation of the earphones. These two signals cancel each other and provide noise suppression at the ear. The device consists of an ultra-low noise microphone preamplifier to set input impedance and gain, followed by an analog signal processing block, and a capacitorless headphone amplifier. The headphone amplifier does not require the large output-coupling capacitors used by conventional single-supply headphone amplifiers, and can output 33mW into a 16Ω headphone. The product also features undervoltage lockout and comprehensive clickand-pop suppression circuitry. See the Functional Diagram/Typical Applications Circuit for further details.

Modes of Operation

The MAX9895A features three modes of operation; active noise canceling (ANC) on or off, and push-to-listen (PTL). The ANC-on mode provides full noise canceling and provides line-input mixing to the headphones. This allows music to be played while noise canceling is operational. The ANC-off mode disables the microphone preamplifiers and noise processing blocks, but allows the line inputs to operate normally. This gives flexibility to the design such that music can still be played through the headphones while noise canceling is inactive.

The PTL mode connects the microphone preamplifier directly to the headphone amplifier, bypassing the noise cancellation, and attenuates the line-input signal. PTL mode gives the user the option of listening to the surroundings without removing the headphones. See Table 1 for hardware mode settings.

Microphone Preamplifier

The MAX9895A features an ultra-low noise microphone input preamplifier. Using an inverting op amp design with external input and feedback resistors allows flexibility in setting input impedance and gain. The microphone gain can be adjusted in two ways: adjust the feedback resistor in the preamplifier stage by use of a potentiometer or setting I²C registers using a microcontroller to adjust the gain after the analog processing stage.

Microphone Bias Supply

The MAX9895A provides a low-noise voltage bias designed for biasing electret condenser microphones (ECM). The bias output is regulated to 2.5V.

Table 1. Mode Selection (in Hardware Mode)

SDA LEVEL	CONFIGURATION
GND	(PTL Mode) LINEIN_ is attenuated, MICOUT_ signal is passed directly to the headphone driver without filtering and phase reversal.
Hi-Z	ANC on
V _{DD}	ANC off (only HP amps are active)

Microphone Output

The outputs of the microphone preamplifiers are provided to allow for external adjustment of the gain of the preamplifier and to provide a path for voice transmission (headset) applications.

Programmable Gain

The second gain stage can be programmed in 0.5dB steps to compensate for microphone and headphone sensitivity. This requires a microcontroller connected to the I²C bus, which operates in slave mode. An alternate solution for gain setting is to add a trim-pot to the feedback resistor of the microphone preamplifier. See the *Typical Application Circuit*.

Analog Signal Processing

This block creates the noise cancellation signal. The signal processing block uses the output of the microphone preamp and external components to create a headphone signal that has the same amplitude, but opposite phase as outside noise that leaks through the mechanical isolation of the earphones, so both waves cancel each other. **Note:** The choice of external components depends on the headset characteristics. Please contact your local Maxim sales office for more information on determining the proper component values for the *Analog Signal Processing* section.

Headphone Amplifier

The stereo headphone amplifier is capable of delivering 33mW into 16Ω loads and has a gain (line in to headphone out) of 1V/V for the MAX9895AA. The input to the headphone amplifier is a linear sum of three signals: line in (external input), mic gain (output of analog signal processing block) and PTL gain (ANC bypass).

Unlike conventional single-supply, single-ended amplifiers, the MAX9895A headphone amplifier does not need large DC-blocking caps, as the outputs are referred to VCC/2, which is the bias output voltage of the amplifier. Conventional single-supply headphone amplifiers require large coupling capacitors to block the output DC bias from the headphone. The MAX9895A architecture uses a high-efficiency charge pump to create an internal midbias supply voltage (VMID). This keeps supply current low and allows the amplifier outputs to be connected directly to the headphones without the need for these large coupling capacitors.

Serial Interface

The MAX9895A features an I²C, 2-wire serial interface consisting of a serial-data line (SDA) and a serial-clock line (SCL). SDA and SCL facilitate communication between the MAX9895A and the master at clock rates up to 400kHz. Figure 1 shows the 2-wire interface timing diagram. The MAX9895A is a receive-only slave device relying on the master to generate the SCL signal. The MAX9895A cannot write to the SDA bus except to acknowledge the receipt of data from the master. The master, typically a microcontroller, generates SCL and initiates data transfer on the bus. If the serial interface is not used, the SCL pin must be tied to GND to disable this feature and allow the device to be used in hardware mode (no microcontroller).

A master device communicates to the MAX9895A by transmitting the proper address followed by the data word. Each transmit sequence is framed by a START (S) or REPEATED START (Sr) condition and a STOP (P) con-

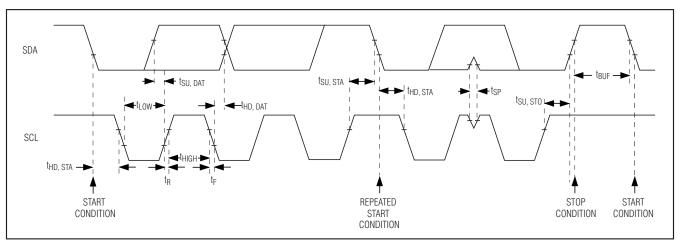


Figure 1. 2-Wire Serial-Interface Timing Diagram

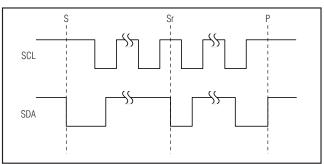


Figure 2. START, STOP, and REPEATED START Conditions

dition. Each word transmitted over the bus is 8 bits long and is always followed by an acknowledge clock pulse.

The MAX9895A SDA line operates as both an input and an open-drain output. A pullup resistor, greater than 500Ω , is required on the SDA bus. The MAX9895A SCL line operates as an input only. A pullup resistor, greater than 500Ω , is required on SCL if there are multiple masters on the bus, or if the master in a single-master system has an open-drain SCL output. Series resistors in line with SDA and SCL are optional. Series resistors protect the digital inputs of the MAX9895A from high-voltage spikes on the bus lines, and minimize crosstalk and undershoot of the bus signals.

Bit Transfer

One data bit is transferred during each SCL cycle. The data on SDA must remain stable during the high period of the SCL pulse. Changes in SDA while SCL is high are control signals (see the *START and STOP Conditions* section). SDA and SCL idle high when the I²C bus is not busy.

START and STOP Conditions

SDA and SCL idle high when the bus is not in use. A master device initiates communication by issuing a START (S) condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP (P) condition is a low-to-high transition on SDA while SCL is high (Figure 2). A START condition from the master signals the beginning of transmission to the MAX9895A. The master terminates transmission and frees the bus by issuing a STOP condition. The bus remains active if a REPEATED START (Sr) condition is generated instead of a STOP condition.

Early STOP Conditions

The MAX9895A recognizes a STOP condition at any point during data transmission except if the STOP condition occurs in the same high pulse as a START condition.

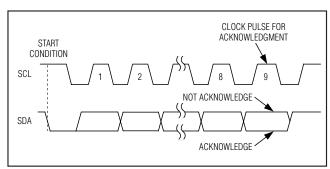


Figure 3. Acknowledge

Slave Address

The MAX9895A is available with 0x40 preset slave addresses. The address is defined as the seven most significant bits (MSBs) followed by the read/write (R/W) bit. The address is the first byte of information sent to the MAX9895A after the START condition. The MAX9895A is a slave device only capable of being written to. The sent R/W bit must always be a zero when configuring the MAX9895A.

The MAX9895A acknowledges the receipt of its address even if R/W is set to 1. However, the MAX9895A does not drive SDA. Addressing the MAX9895A with R/W set to 1 causes the master to receive all 1s regardless of the contents of the command register.

Acknowledge

The acknowledge bit (ACK) is a clocked 9th bit that the MAX9895A uses to handshake receipt of each byte of data (see Figure 3). The MAX9895A pulls down SDA during the master-generated 9th clock pulse. The SDA line must remain stable and low during the high period of the acknowledge clock pulse. Monitoring ACK allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master can reattempt communication.

Write Data Format

A write to the MAX9895A includes transmission of a START (S) condition, the slave address with the R/W bit reset to 0, one byte of data to configure the command register, and a STOP (P) condition. Figure 4 illustrates the proper format for one frame.

The MAX9895A only accepts write data, but it acknowledges the receipt of its address byte with the R/W bit set high. The MAX9895A does not write to the SDA bus

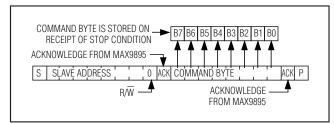


Figure 4. Write Data Format Example

in the event that the R/W bit is set high. Subsequently, the master reads all 1s from the MAX9895A. Always reset the R/W bit to 0 to avoid this situation.

I²C-Enabled Software Mode

The MAX9895A can operate with or without an external microcontroller (μ C). When a μ C is present, commands are sent through the I²C protocol (SCL, SDA).

I²C-Disabled Hardware Mode

By tying SCL to ground, the I²C interface is disabled and the device operates in hardware mode. In this case, the SDA pin operates as a MODE select. Table 1 shows different configurations with the SDA level.

_Application Information

Input-Coupling Capacitor

The input capacitor (C_{IN}), in conjunction with the input resistor (R_{IN}), forms a highpass filter that removes the DC bias from an incoming signal (see the *Functional Diagram/Typical Applications Circuit*). The AC-coupling capacitor allows the device to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN} C_{IN}}$$

Choose the CIN so that f-3dB is well below the lowest frequency of interest. Setting f-3dB too high affects the

device's low-frequency response. Use capacitors whose dielectrics have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, can result in increased distortion at low frequencies.

Apply same method for microphone input-coupling capacitor (C_{PREIN}). The R_{IN} for microphone input is R_{PREIN} .

Setting the Gains

The gains of the microphone input preamplifiers are set through the feedback using the following equation:

$$A_V(V/V) = -(R_F/R_{IN})$$

In stand-alone control mode, the internal gain stage for MIC GAIN is fixed at 11.5dB and the PTL GAIN stage is fixed at -5.5dB. In software control mode (I²C mode), the internal gain stage stages, MIC GAIN and PTL GAIN, are programmable through the I²C registers. See the *Serial Interface* section for more information.

The LINE IN and HEADPHONE AMP stages each have fixed voltage gain of 0dB.

Charge-Pump Capacitor Selection

Use ceramic capacitors with a low ESR for optimum performance. For optimal performance over the extended temperature range, select capacitors with an X7R dielectric. Table 2 lists suggested manufacturers.

Layout and Grounding

Proper layout and grounding are essential for optimum performance. Connect PGND and GND together at a single point on the PCB. Place the power-supply bypass capacitor and the charge-pump hold capacitor as close as possible to the MAX9895A. Route PGND and all traces that carry switching transients away from GND and the audio signal path. The thin QFN package features an exposed pad that improves thermal efficiency. Ensure that the exposed pad is electrically connected to PGND and is isolated from VDD, PVDD, and CPVDD.

Table 2. Suggest Capacitor Manufacturers

SUPPLIER	PHONE	FAX	WEBSITE
Taiyo Yuden	800-348-2496	847-925-0899	www.t-yuden.com
TDK	847-803-6100	847-390-4405	www.component.tdk.com
Murata	770-436-1300	770-436-3030	www.murata.com

Table 3. I²C Register Table

ADDRESS	TYPE	POR	NAME	7	6	5	4	3	2	1	0
0x00	R/W	0x0B	ANC_GAIN_LEFT	Χ	Χ	Χ	ANC GAIN setting for LEFT CHANNEL				HANNEL
0x01	R/W	0x0B	ANC_GAIN_RIGHT	Χ	Χ	Χ	ANG	ANC GAIN setting for RIGHT CHANNEL			
0x02	R/W	0x0B	PTL_GAIN_LEFT	Χ	X X PTL GAIN setting for LEFT CHANNEL					HANNEL	
0x03	R/W	0x0B	PTL_GAIN_RIGHT	Χ	X X PTL GAIN setting for RIGHT CHANNEL					CHANNEL	
0x04	R/W	0x00	MODE		X			0	PTL	ANC	SHDN

Table 4. Gain Setting Register 0x00, 0x01, 0x02, 0x03

HEX	0x00, 0x01 ANC GAIN [dB]	HEX	0x00, 0x01 ANC GAIN [dB]	HEX	0x00, 0x01 ANC GAIN [dB]		
0x00	-6.0	0x08	-10.0	0x10	-14.0		
0x01	-6.5	0x09	-10.5	0x11	-14.5		
0x02	-7.0	0x0A	-11.0	0x12	-15.0		
0x03	-7.5	0x0B (POR)	-11.5	0x13	-15.5		
0x04	-8.0	0x0C	-12.0	0x14	-16.0		
0x05	-8.5	0x0D	-12.5	0x15	-16.5		
0x06	-9.0	0x0E	-13.0	0x16	-17.0		
0x07	-9.5	0x0F	-13.5	0x17	-17.5		
HEX	0x02, 0x03 PTL GAIN [dB]	HEX	0x02, 0x03 PTL GAIN [dB]	HEX	0x02, 0x03 PTL GAIN [dB]		
0x00	-0.0	0x08	-4.0	0x10	-8.0		
0x01	-0.5	0x09	-4.5	0x11	-8.5		
0x02	-1.0	0x0A	-5.0	0x12	-9.0		
0x03	-1.5	0x0B (POR)	-5.5	0x13	-9.5		
0x04	-2.0	0x0C	-6.0	0x14	-10.0		
0x05	-2.5	0x0D	-6.5	0x15	-10.5		
0x06	-3.0	0x0E	-7.0	0x16	-11.0		
0x07	-3.5	0x0F	-7.5	0x17	-11.5		

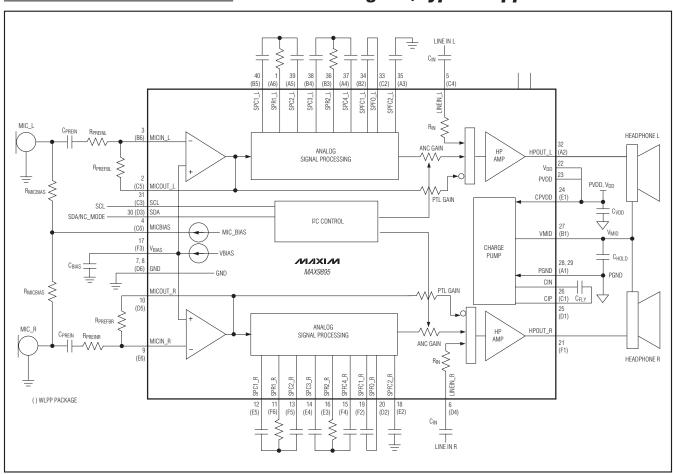
Table 5. Mode Register 0x04

BIT	NAME	POR	FUNCTION
0	SHDN	0	0: Shut down 1: Play
1	ANC	O: Noise cancelling on 1: Noise cancelling off (microphone muted)	
2	PTL	0	0: LINEIN routed to HPOUT 1: LINEIN attenuated; MICOUT routed to HPOUT

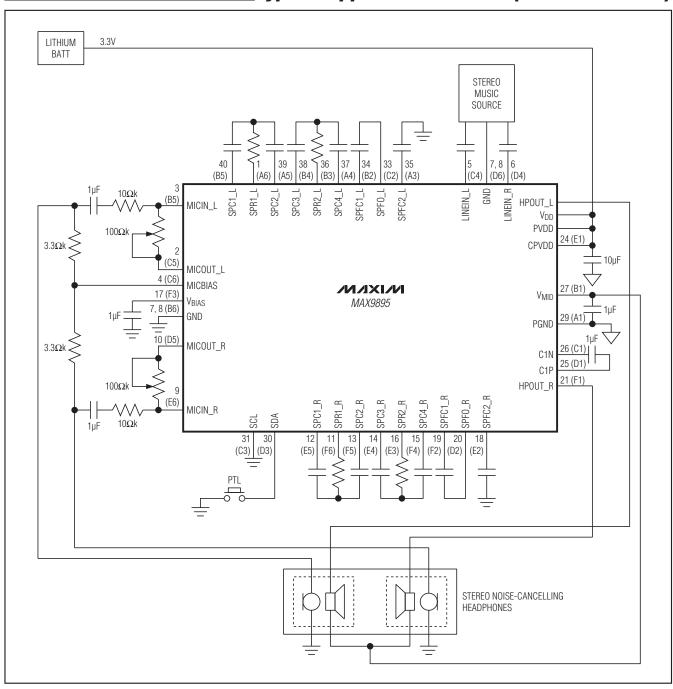
Table 6. Source Select

INPUT	MODE							
INPUT	ANC ON	ANC OFF	PTL					
Microphone In	NC mode, inverting, gain defined by I2C REG 01 and 02	Muted	Noninverting, gain defined by I ² C REG 03 and 04					
Line In	Noninverting, 0db	Noninverting, 0dB	Attenuated					

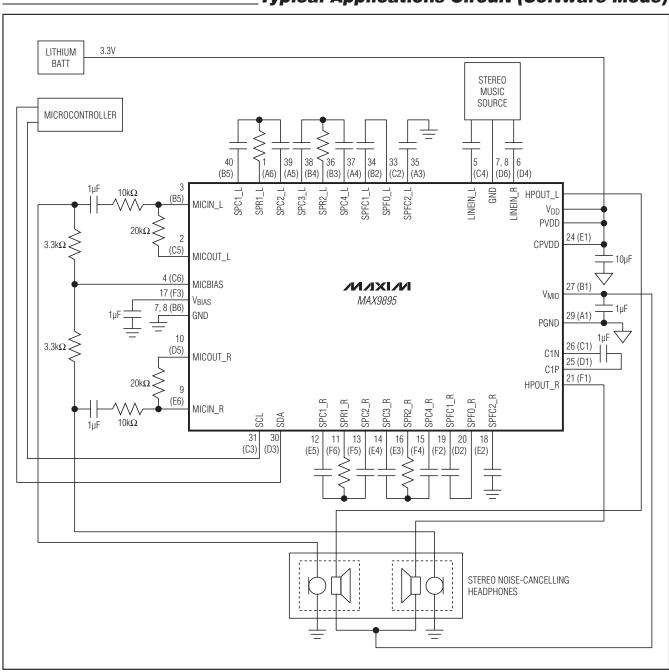
Functional Diagram/Typical Applications Circuit



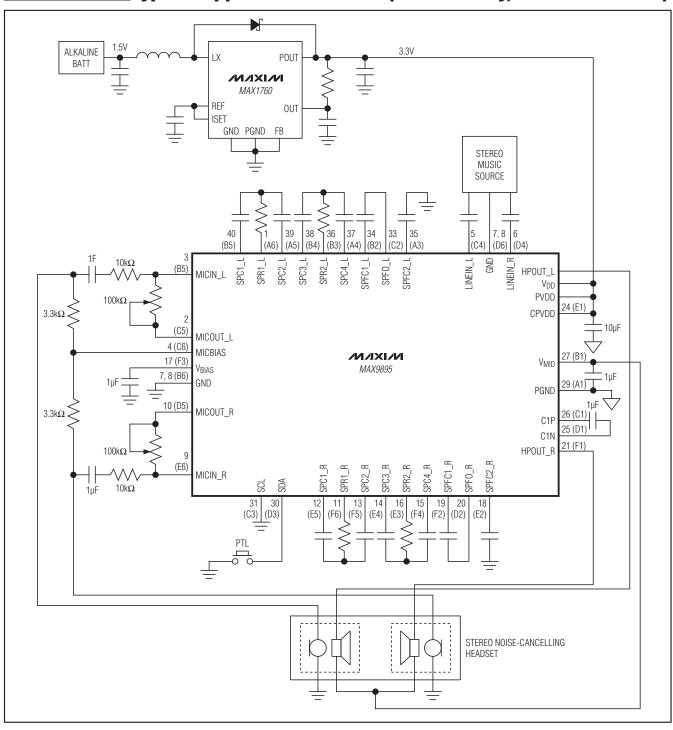
Typical Applications Circuit (Hardware Mode)



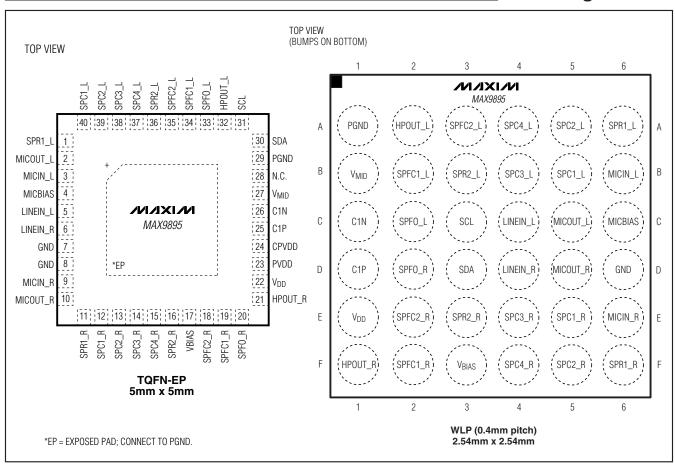
Typical Applications Circuit (Software Mode)



Typical Applications Circuit (AAA Battery, Hardware Mode)



Pin Configurations



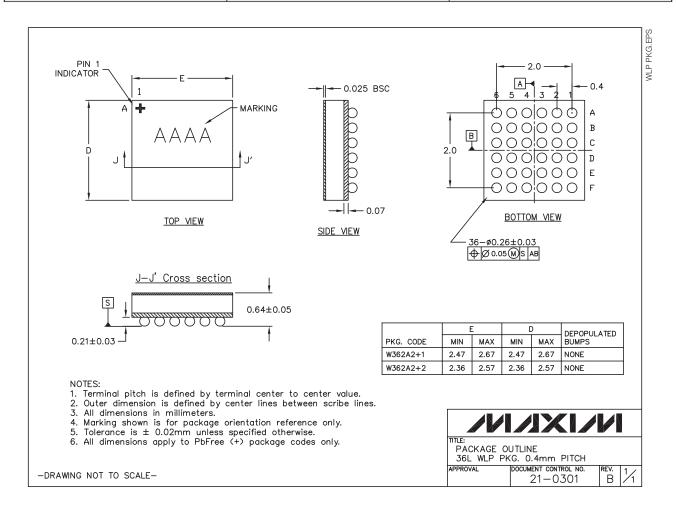
_____Chip Information

PROCESS: BiCMOS

Package Information

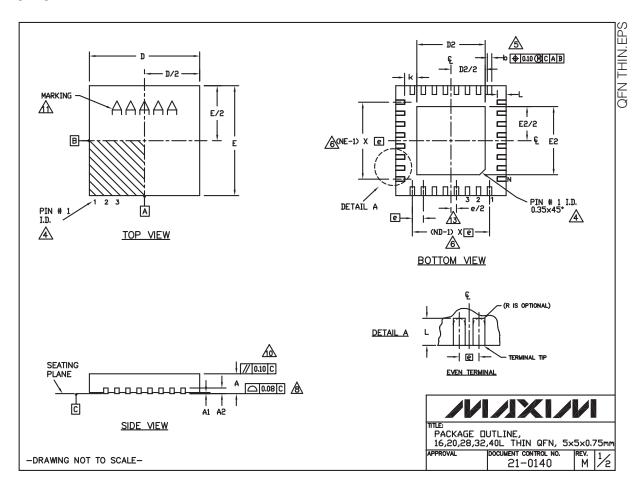
For the latest package outline information and land patterns, go to www.maxim-ic.com/package. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	DOCUMENT NO.
36 WLP	W362A2+2	<u>21-0301</u>
40 TQFN	T4055+1	<u>21-0140</u>



Package Information (continued)

For the latest package outline information and land patterns, go to www.maxim-ic.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.



Package Information (continued)

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COMMON DIMENSIONS															
PKG.	16L 5x5		20L 5x5		28L 5x5		32L 5x5			40L 5x5					
SYMBOL	MIN. NOM. MAX.		MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	MIN.	NDM.	MAX.	MIN.	NOM.	MAX.	
Α	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80	0.70	0.75	0.80
A1	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05	0	0.02	0.05
A2	0.20 REF.		0.20 REF.		0.20 REF.		0.20 REF.			0.20 REF.					
b	0.25	0.30	0.35	0.25	0.30	0.35	0.20	0.25	0.30	0.20	0.25	0.30	0.15	0.20	0.25
D	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
E	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10	4.90	5.00	5.10
e	0.80 BSC.		0.65 BSC.		0.50 BSC.		0.50 BSC.			0.40 BSC.					
k	0.25	-	-	0.25	_	_	0.25	-	-	0.25	-	-	0.25	-	_
L	0.30	0.40	0.50	0.45	0.55	0.65	0.45	0.55	0.65	0.30	0.40	0.50	0.30	0.40	0.50
N	16		20		28		32			40					
ND	4		5		7		8		10						
NE	4		5		7		8			10					
JEDEC	WHHB		WHHC		WHHD-1		WHHD-2								

- DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
- 2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- N IS THE TOTAL NUMBER OF TERMINALS.
- THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE
- ⚠ DIMENSION 6 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN
- 0.25 mm AND 0.30 mm FROM TERMINAL TIP.

 ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
- DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.
- COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
- DRAWING CONFORMS TO JEDEC MO220, EXCEPT EXPOSED PAD DIMENSION FOR T2855-3, T2855-6, T4055-1 AND T4055-2.
- √O₂ WARPAGE SHALL NOT EXCEED 0.10 mm.
- 11. MARKING IS FOR PACKAGE DRIENTATION REFERENCE ONLY.
- NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- △3 LEAD CENTERLINES TO BE AT TRUE POSITION AS DEFINED BY BASIC DIMENSION "e", ±0.05.
- 14. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND PHEREE (+) PKG. CODES.

-DRAWING NOT TO SCALE-

EXPOSED PAD VARIATIONS								
PKG.		D2		E2				
CODES	MIN. NOM.		MAX.	MIN.	NDM.	MAX.		
T1655-2	3.00	3.10	3.20	3.00	3.10	3.20		
T1655-3	3.00	3.10	3.20	3.00	3.10	3.20		
T1655-4	2.19	2.29	2.39	2.19	2.29	2.39		
T165N-1	3.00	3.10	3.20	3.00	3.10	3.20		
T2055-3	3.00	3.10	3.20	3.00	3.10	3.20		
T2055-4	3.00	3.10	3.20	3.00	3.10	3.20		
T2055-5	3.15	3.25	3.35	3.15	3.25	3.35		
T2055MN-5	3.15	3.25	3.35	3.15	3.25	3.35		
T2855-3	3.15	3.25	3.35	3.15	3,25	3.35		
T2855-4	2.60	2.70	2.80	2.60	2.70	2.80		
T2855-5	2.60	2.70	2.80	2.60	2.70	2.80		
T2855-6	3.15	3.25	3.35	3.15	3.25	3.35		
T2855-7	2.60	2.70	2.80	2.60	2.70	2.80		
T2855-8	3.15	3.25	3.35	3.15	3,25	3.35		
T2855N-1	3.15	3.25	3.35	3.15	3.25	3.35		
T3255-3	3.00	3.10	3.20	3.00	3.10	3.20		
T3255-4	3.00	3.10	3.20	3.00	3.10	3.20		
T3255M-4	3.00	3.10	3.20	3.00	3.10	3.20		
T3255-5	3.00	3.10	3.20	3.00	3.10	3.20		
T3255N-1	3.00	3.10	3.20	3.00	3.10	3.20		
T4055-1	3.40	3.50	3.60	3.40	3.50	3.60		
T4055-2	3.40	3.50	3.60	3.40	3.50	3.60		
T4055N-1	3.40	3.50	3.60	3.40	3.50	3.60		
T4055MN-1	3.40	3.50	3.60	3.40	3.50	3.60		



PACKAGE DUTLINE,

16,20,28,32,40L THIN QFN, 5x5x0.75mm

21-0140

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